



DMTH3004LFG

N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
30V	5.5mΩ @ V _{GS} = 10V	75A
30 V	8.5mΩ @ V _{GS} = 4.5V	50A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

Features and Benefits

- Low R_{DS(ON)} Ensures On-State Losses are Minimized
- Excellent Q_{gd} x R_{DS(ON)} Product (FOM)
- Small Form Factor Thermally Efficient Package Enables Higher-Density End Products
- Occupies just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% UIS (Avalanche) Rated
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMTH3004LFGQ</u>)

Mechanical Data

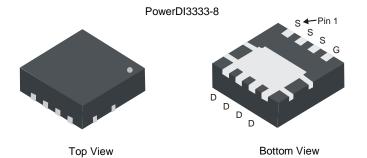
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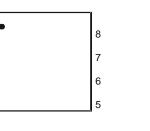
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- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.072 grams (Approximate)

Top View





Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH3004LFG-7	PowerDI3333-8	2,000/Tape & Reel
DMTH3004LFG-13	PowerDI3333-8	3,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



YS5 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 = 2018) WW = Week Code (01 to 53)



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	30	V	
Gate-Source Voltage	V _{GSS}	±16	V	
Continuous Drain Current (Notes 6 & 9) V_{GS} = 10V	T _C = +25°C T _C = +100°C	ID	75 52	А
Continuous Drain Current (Note 5) V_{GS} = 10V	T _A = +25°C T _A = +100°C	ID	15 10	А
Maximum Continuous Body Diode Forward Current (Note	5)	Is	3	А
Pulsed Drain Current (100µs Pulse, Duty Cycle = 1%)		I _{DM}	250	А
Pulsed Body Diode Forward Current (100µs Pulse, Duty C	Cycle = 1%)	I _{SM}	250	А
Avalanche Current, L = 0.3mH		I _{AS}	27	А
Avalanche Energy, L = 0.3mH		E _{AS}	110	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6) $T_{C} = +25^{\circ}C$		PD	50	W
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	3	°C/W
Total Power Dissipation (Note 5) $T_A = +25^{\circ}C$		PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{ extsf{ heta}JA}$	60	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						-
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	_	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	IDSS		—	1	μA	$V_{DS} = 24V, V_{GS} = 0V$
Gate-Source Leakage			—	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1	—	3	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance			4.1 5.5	mΩ	$V_{GS} = 10V, I_D = 20A$	
	R _{DS(ON)}		6.2	8.5	mΩ	$V_{GS} = 4.5V, I_D = 7A$
Diode Forward Voltage	V _{SD}		0.7	1	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	-	2370	_		$V_{DS} = 15V, V_{GS} = 0V,$ f = 1MHz
Output Capacitance	C _{oss}	-	1360	_	pF	
Reverse Transfer Capacitance	Crss	_	240	—		
Gate Resistance	Rg	_	0.6	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	20	—		
Total Gate Charge (V _{GS} = 10V)	Qq	_	44	—	-0	V _{DS} = 15V, I _D = 20A
Gate-Source Charge	Q _{qs}		7	—	nC	
Gate-Drain Charge	Q _{qd}	_	8	—		
Turn-On Delay Time	t _{D(ON)}		6.2	—		$V_{DD} = 15V, V_{GS} = 10V,$ $R_L = 0.75\Omega, R_g = 3\Omega, I_D = 20A$
Turn-On Rise Time	t _R		4.3	_		
Turn-Off Delay Time	t _{D(OFF)}		21	—	ns	
Turn-Off Fall Time	t _F	_	8	—		
Body Diode Reverse Recovery Time	t _{RR}	_	25	_	ns	
Body Diode Reverse Recovery Charge	Q _{RR}	_	37	_	nC	I _F = 15A, di/dt = 500A/μs

5. R_{0JA} is determined with the device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. R_{0JC} is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design.

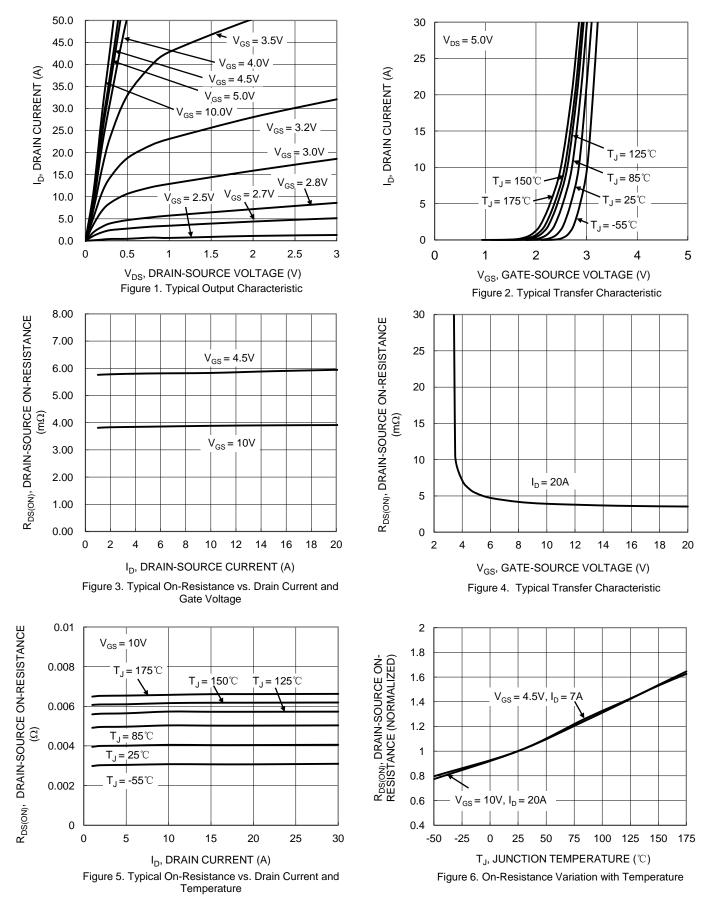
6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Short duration pulse test used to minimize self-heating effect.

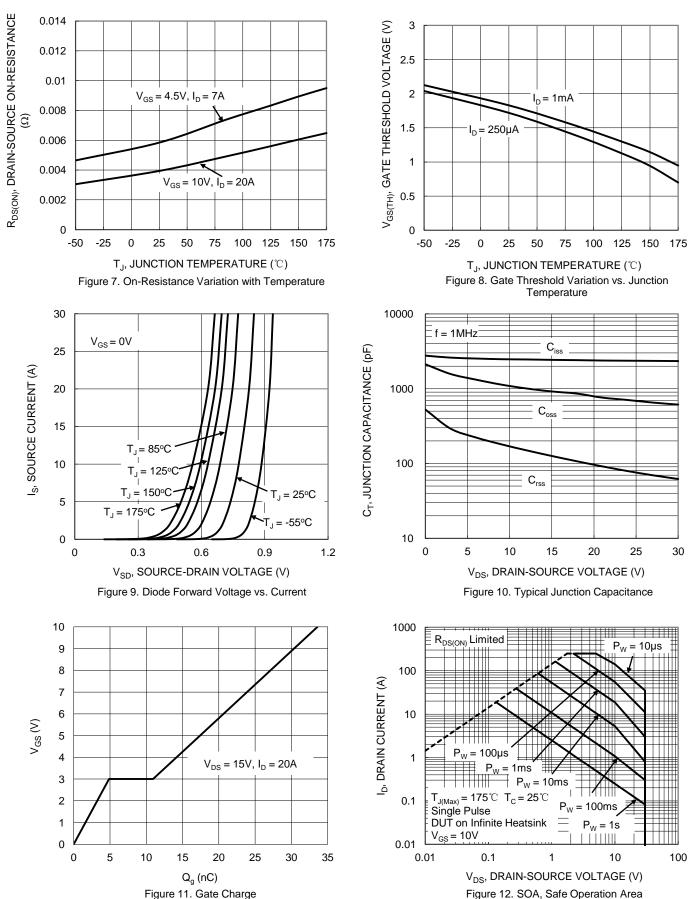
B. Guaranteed by design. Not subject to product testing.
Package limited.



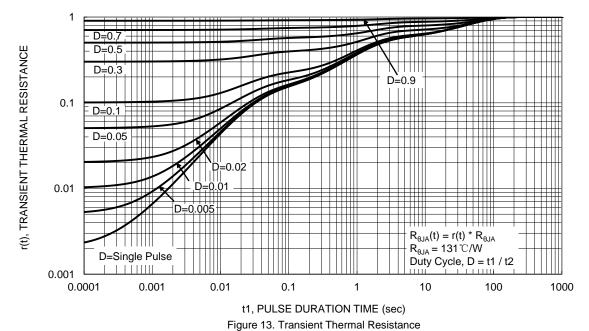
DMTH3004LFG











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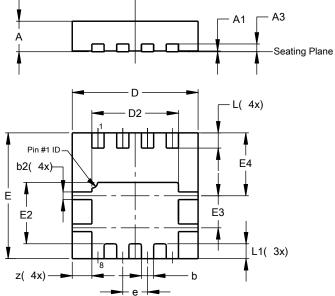
Document number: DS40696 Rev. 3 - 2



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

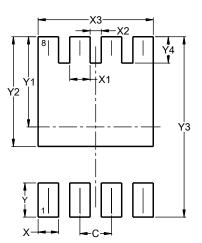
PowerDI3333-8



	PowerDI3333-8					
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3	-	-	0.203			
b	0.27	0.37	0.32			
b2	0.15	0.25	0.20			
D	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
Е	3.25	3.35	3.30			
E2	1.56	1.66	1.61			
E3	0.79	0.89	0.84			
E4	1.60	1.70	1.65			
е	-	-	0.65			
L	0.35	0.45	0.40			
L1	_	_	0.39			
z	_	-	0.515			
All I	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI3333-8

Dimensions	Value (in mm)			
С	0.650			
Х	0.420			
X1	0.420			
X2	0.230			
X3	2.370			
Y	0.700			
Y1	1.850			
Y2	2.250			
Y3	3.700			
Y4	0.540			



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